

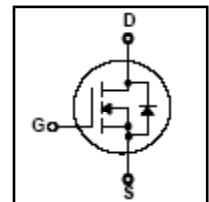
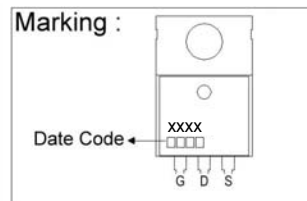
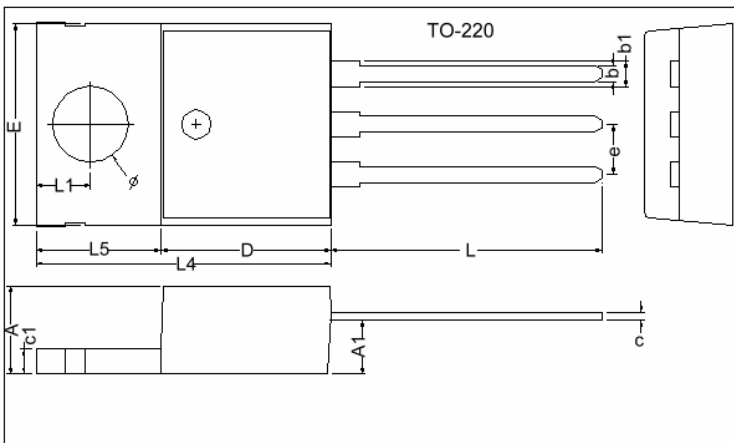
N-Channel MOSFET

| | |
|--------------|---------------|
| V_{DSS} | 500V |
| $R_{DS(ON)}$ | 0.38 Ω |
| I_D | 16A |

Features

- * Very Low Intrinsic Capacitances
- * Excellent Switching Characteristics
- * Superior Avalanche Rugged Technology
- * Robust Gate Oxide Technology
- * Lower $R_{DS(ON)}$

Package Dimensions



| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|------|---------------|------------|-------|
| | Min. | Max. | | Min. | Max. |
| A | 4.40 | 4.80 | c1 | 1.25 | 1.45 |
| b | 0.76 | 1.00 | b1 | 1.17 | 1.47 |
| c | 0.36 | 0.50 | L | 13.25 | 14.25 |
| D | 8.60 | 9.00 | e | 2.54 REF. | |
| E | 9.80 | 10.4 | L1 | 2.60 | 2.89 |
| L4 | 14.7 | 15.3 | \varnothing | 3.71 | 3.96 |
| L5 | 6.20 | 6.60 | A1 | 2.60 | 2.80 |

Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise specified

| Symbol | Parameter | Value | Units |
|----------------|---|-------------|---------------------|
| V_{DSS} | Drain-Source Voltage | 500 | V |
| I_D | Drain Current – Continuous ($T_C = 25^\circ\text{C}$) | 16 | A |
| | Drain Current – Continuous ($T_C = 100^\circ\text{C}$) | 3.5 | A |
| I_{DM} | Drain Current – Pulsed (Note 1) | 40 | A |
| V_{GS} | Gate-Source Voltage | 3-5 | V |
| E_{AS} | Single Pulsed Avalanche Energy (Note 2) | 710 | mJ |
| I_{AR} | Avalanche Current (Note 1) | 10 | A |
| E_{AR} | Repetitive Avalanche Energy (Note 1) | 15.8 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | 4.5 | V/ns |
| P_D | Power Dissipation ($T_C = 25^\circ\text{C}$) | 157 | W |
| | – Derate above 25°C | 1.14 | W/ $^\circ\text{C}$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to +150 | $^\circ\text{C}$ |
| T_L | Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | 300 | $^\circ\text{C}$ |

* Drain current limited by maximum junction temperature

Thermal Resistance Characteristics

| Symbol | Parameter | Typ. | Max. | Units |
|-----------------|---------------------|------|------|---------------------------|
| $R_{\theta JC}$ | Junction-to-Case | -- | 0.85 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta CS}$ | Case-to-Sink | 0.5 | -- | |
| $R_{\theta JA}$ | Junction-to-Ambient | -- | 63.5 | |

Electrical Characteristics $T_C=25\text{ }^{\circ}\text{C}$ unless otherwise specified

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--|---|---|-----|------|------|-------|
| On Characteristics | | | | | | |
| V _{GS} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250 μA | 2 | -- | 4 | V |
| R _{DS(ON)} | Static Drain-Source On-Resistance | V _{GS} = 10 V, I _D = 5 A | -- | 0.38 | 0.75 | Ω |
| Off Characteristics | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0 V, I _D = 250 μA | 500 | -- | -- | V |
| ΔBV _{DSS} /ΔT _J | Breakdown Voltage Temperature Coefficient | I _D = 250 μA, Referenced to25℃ | -- | 0.7 | -- | V/℃ |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 600 V, V _{GS} = 0 V | -- | -- | 1 | μA |
| | | V _{DS} = 480 V, T _C = 125℃ | -- | -- | 10 | μA |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = 30 V, V _{DS} = 0 V | -- | -- | 100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = -30 V, V _{DS} = 0 V | -- | -- | -100 | nA |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz | -- | 1550 | 2020 | pF |
| C _{oss} | Output Capacitance | | -- | 164 | 212 | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 17 | 24 | pF |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-On Time | V _{DS} = 300 V, I _D = 10 A, R _G = 25 Ω (Note 4,5) | -- | 17 | 45 | ns |
| t _r | Turn-On Rise Time | | -- | 65 | 145 | ns |
| t _{d(off)} | Turn-Off Delay Time | | -- | 141 | 270 | ns |
| t _f | Turn-Off Fall Time | | -- | 75 | 160 | ns |
| Q _g | Total Gate Charge | V _{DS} = 480V, I _D = 10 A, V _{GS} = 10 V (Note 4,5) | -- | 43 | 55 | nC |
| Q _{gs} | Gate-Source Charge | | -- | 6.4 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 18 | -- | nC |
| Source-Drain Diode Maximum Ratings and Characteristics | | | | | | |
| I _S | Continuous Source-Drain Diode Forward Current | | -- | -- | 10 | A |
| I _{SM} | Maximum Pulsed Source-Drain Diode Forward Current | | -- | -- | 40 | |
| V _{SD} | Source-Drain Diode Forward Voltage | I _S = 10A, V _{GS} = 0 V | -- | -- | 1.4 | V |
| trr | Reverse Recovery Time | I _S = 10A, V _{GS} = 0 V | -- | 425 | -- | ns |
| Qrr | Reverse Recovery Charge | di _F /dt = 100 A/μs (Note 4) | -- | 4.4 | -- | μC |

Notes ;

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L=14.2\text{ mH}$, $V_{DD}=50\text{ V}$, $R_G=25\text{ }\Omega$, Starting $T_J=25\text{ }^{\circ}\text{C}$
3. $I_{SD} \leq 10\text{ A}$, $di/dt \leq 200\text{ A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J=25\text{ }^{\circ}\text{C}$
4. Pulse Test : Pulse Width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 2\%$
5. Essentially Independent of Operating Temperature

Typical Characteristics

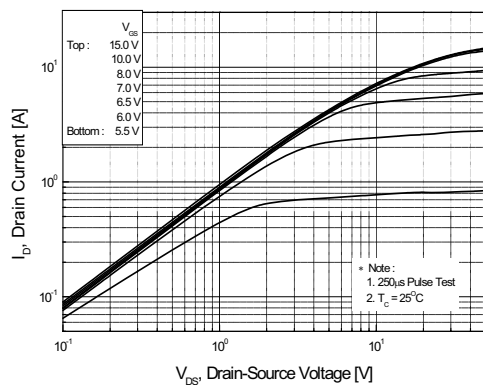


Figure 1. On Region Characteristics

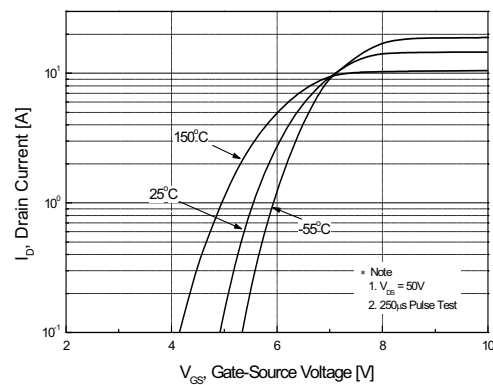


Figure 2. Transfer Characteristics

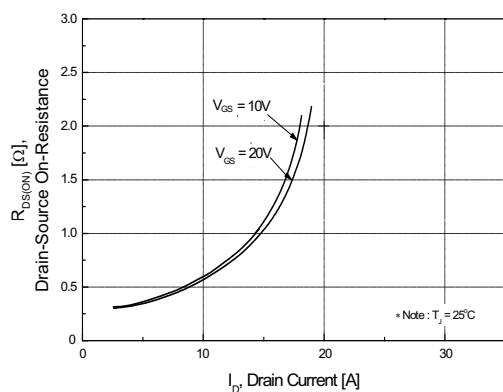


Figure 3. On Resistance Variation vs Drain Current and Gate Voltage

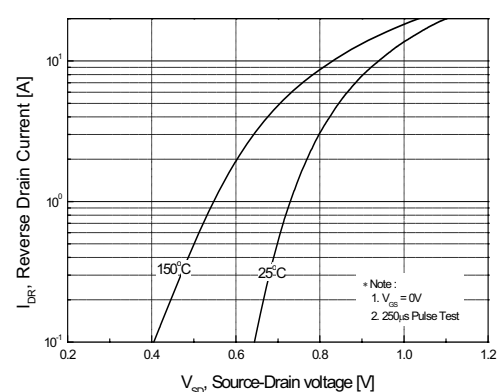


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

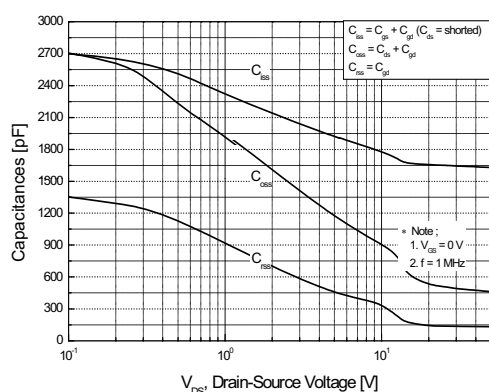


Figure 5. Capacitance Characteristics

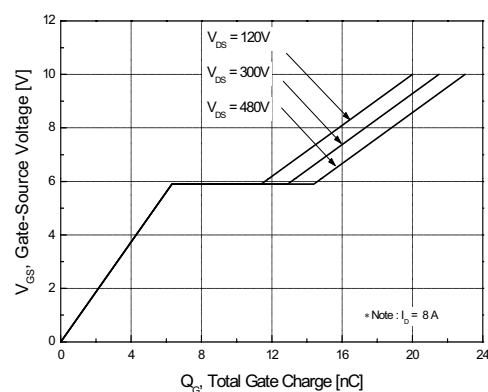


Figure 6. Gate Charge Characteristics

Typical Characteristics (continued)

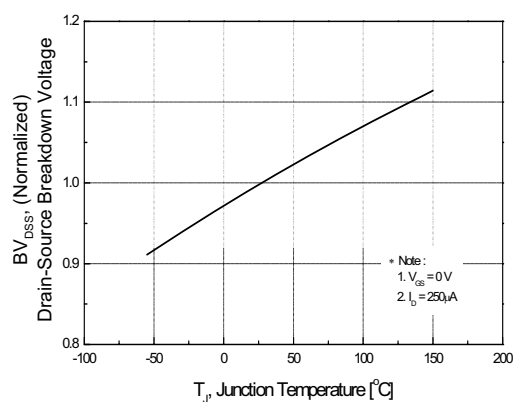


Figure 7. Breakdown Voltage Variation vs Temperature

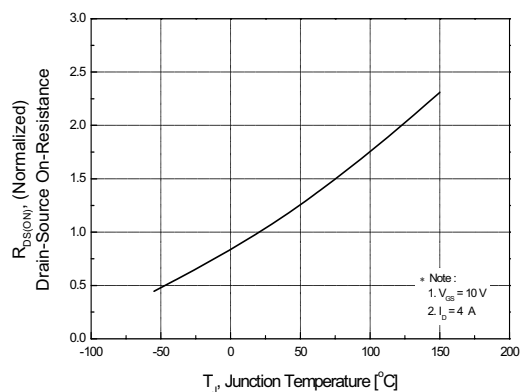


Figure 8. On-Resistance Variation vs Temperature

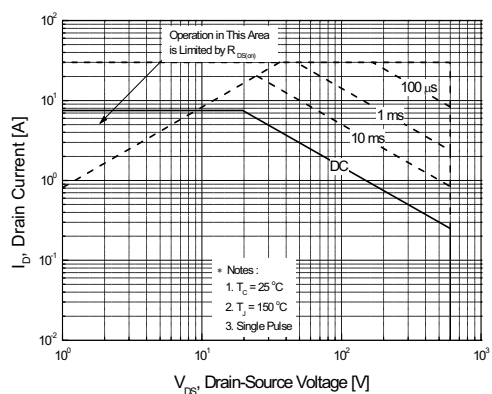


Figure 9. Maximum Safe Operating Area

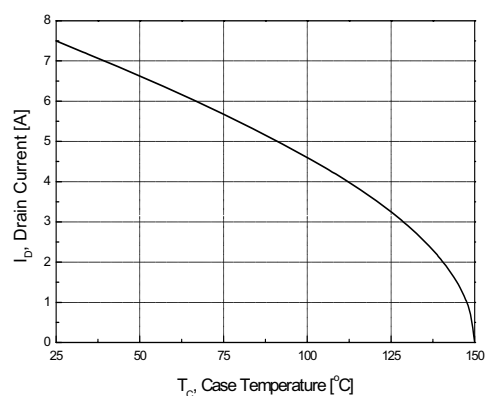


Figure 10. Maximum Drain Current vs Case Temperature

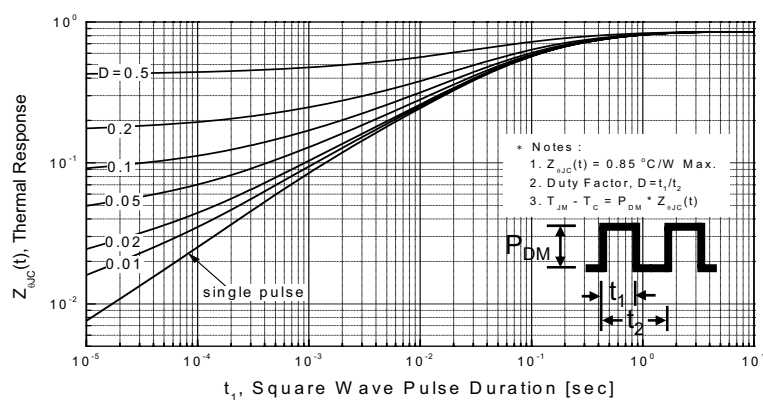


Figure 11. Transient Thermal Response Curve

Fig 12. Gate Charge Test Circuit & Waveform

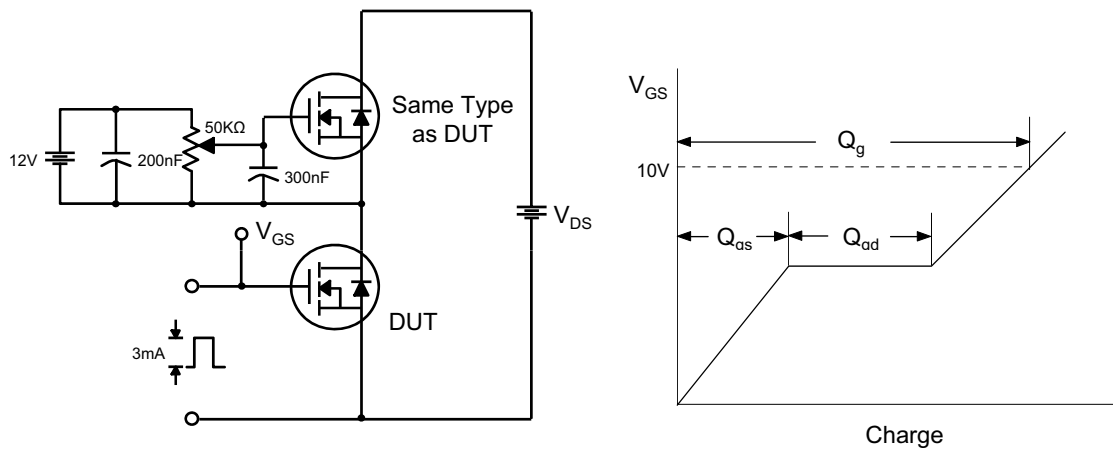


Fig 13. Resistive Switching Test Circuit & Waveforms

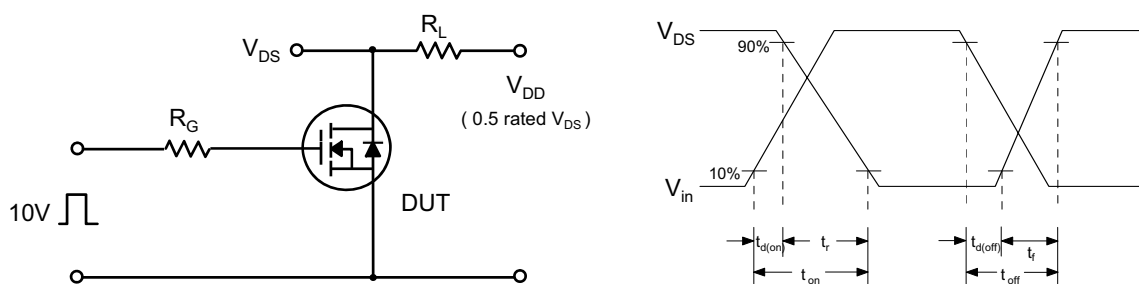


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

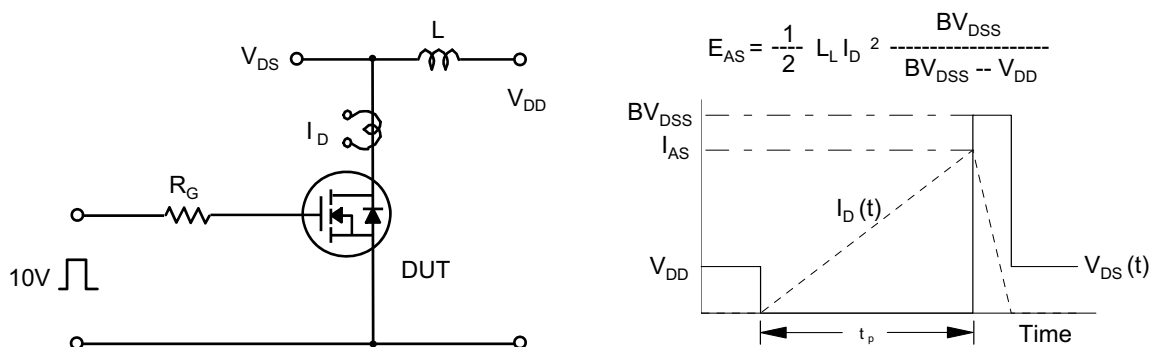


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

